

AC—coupled pitch adapters for silicon strip detectors

Thursday 18 November 2010 11:10 (20 minutes)

Silicon strip detector modules that are used in tracker systems of high energy physics experiments consists of readout hybrid board, the sensor itself and pitch adapter (PA) in between hybrid and sensor. Modern strip detectors are almost exclusively AC-coupled because of high leakage current due to the harsh radiation environment. The AC-coupling requires resistive isolation of implanted strips from the DC-biasing circuit. Strip isolation is commonly realized by integrated poly-silicon bias resistors, where the resistance value is typically around $1\text{M}\ \Omega$. We present a novel approach for implementing the AC-coupling in the pitch adapter. AC-coupled PA's have been processed on ordinary glass glass wafers. The two layer fan metallization is aluminum and the intermediate capacitor insulator is aluminum oxide (Al_2O_3) deposited by the Atomic Layer Deposition (ALD) method. ALD is self-limiting Chemical Vapor Deposition (CVD) process, which characteristically results in pinhole-free thin films. The temperature of ALD Al_2O_3 deposition is 300°C , thus it is appropriate for standard glass wafers, which are limited to about 400°C in process steps. The bias resistors are made on the glass wafer by sputtering tungsten nitride (WN_x). The deposition of WN_x takes place at approximately room temperature and the resistors are patterned by wet etching with hydrogen peroxide. The electrical characterization of AC-coupled PA's indicate very good breakdown performance of the Al_2O_3 capacitors and homogeneity of WN_x resistance values. A DC-coupled n+/p-/p+ strip detector made of p-type Fz-Si and irradiated with protons to a fluence of 3×10^{14} neq/cm² was attached to the CMS APV readout hybrid with an AC-coupled PA. The strip detectors size is $4\text{cm} \times 4\text{cm}$ and it has 768 strips. Our test beam results indicate a signal-to-noise ratio of 27 for this module.

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Session Classification: Development and Characterization of Strip and Pixel Sensors